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Inner layer isolation distance (IL-TT-TP-PP) ②	0.150 mm	0.175 mm	0.200 mm	0.250 mm	More Options▼
Inner layer annular ring (IAR) ③	0.125 mm	0.150 mm	0.200 mm	More Option	ns▼
Smallest final hole ③	0.45 mm 0.25 mm More Options •				
Holes <= may be reduced ②	0.65 mm 0	.60 mm 0	.55 mm 0.5	60 mm 0.45	5 mm More Options▼
Hole density ③	< 1000/dm ²	< 1500/dn	< 2000/d	dm ² > 2000	1/dm²
Component pad pitch	0.50 mm < 0.50 mm				
Technology class ②	6C				
Advanced options 🗸					UL Marking Editor

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